



# EFR32 Wireless Gecko

## EFR32MR21 Errata

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This document contains information on the EFR32MR21 errata. The latest available revision of this device is revision C.

Errata that have been resolved remain documented and can be referenced for previous revisions of this device.

The device data sheet explains how to identify the chip revision, either from the package marking or electronically.

Errata effective date: June, 2023.

## 1. Errata Summary

The table below lists all known errata for the EFR32MR21 and all unresolved errata of the EFR32MR21.

**Table 1.1. Errata Overview**

Designator	Title/Problem	Workaround Exists	Exists on Revision:	
			B	C
CUR_E304	Higher Than Expected EM2/EM3 Current	No	—	X
GPIO_E302	Increased Leakage Current When EM4WU Pins Are Enabled and the Pin State Is High	Yes	X	X
HFXO_E301	HFXO DISONDEMAND and FORCEEN Can Cause Device to Hang	Yes	X	X
LFXO_E301	LFXO Minimum Load Capacitance	Yes	—	X
RADIO_E308	Low Output Power for 20 dBm Power Amplifier at High Temperature	No	—	X
TIMER_E301	Continuous Overflow and Underflow Interrupts in Quadrature Counting Mode	Yes	X	X
USART_E301	Possible Data Transmission on Wrong Edge in Synchronous Mode	Yes	X	X
USART_E302	Additional SCLK Pulses Can Be Generated in USART Synchronous Mode	Yes	X	X
USART_E304	PRS Transmit Unavailable in Synchronous Secondary Mode	No	X	X
WDOG_E301	Clear Command is Lost Upon EM2 Entry	Yes	X	X

## 2. Current Errata Descriptions

### 2.1 CUR\_E304 – Higher Than Expected EM2/EM3 Current

<b>Description of Errata</b>
Current consumption in EM2 and EM3 is higher than the data sheet specification.
<b>Affected Conditions / Impacts</b>
Systems operating in EM2 and EM3 will experience excess current consumption on the order of 20 $\mu$ A higher than the data sheet specification.
<b>Workaround</b>
There is currently no workaround for this issue.
<b>Resolution</b>
There is currently no resolution for this issue. The higher current number for revision C devices will be published starting with the 1.0 version of the data sheet.

### 2.2 GPIO\_E302 – Increased Leakage Current When EM4WU Pins Are Enabled and the Pin State Is High

<b>Description of Errata</b>
When any of the EM4WU pins are used with the input path enabled and the pin state is high, an extra leakage current of approximately 15 $\mu$ A per pin will be observed in EM0, EM1, EM2, and EM3.
<b>Affected Conditions / Impacts</b>
EM0, EM1, EM2, and EM3 current will be higher by approximately 15 $\mu$ A per pin when any of the EM4WU pins are used with the input path enabled and the pin state is high.
<b>Workaround</b>
There are two workarounds for this issue: <ol style="list-style-type: none"> <li>1. If the input path on the pad is not required, disable the input path on that pad by setting the DINDIS or DINDISALT bits in the GPIO_PORTx_CTRL register. Thus, an EM4WU pin can still be used to drive an output without incurring the extra current leakage when the pin is configured as an output and DINDIS or DINDISALT is set.</li> <li>2. If an input path is required (i.e., MODEN is any value other than DISABLED and DINDIS = 0 or DINDISALT = 0), assign it to a pin which does not have EM4 wakeup capability.</li> </ol> <p>Refer to the device data sheet to determine which pins have or do not have EM4 wake-up functionality.</p>
<b>Resolution</b>
There is currently no resolution for this issue.

### 2.3 HFXO\_E301 — HFXO DISONDEMAND and FORCEEN Can Cause Device to Hang

<b>Description of Errata</b>
With HFXO enabled, when DISONDEMAND is toggled from 0 to 1 followed by a system reset request, a handshake between the EMU and CMU hangs, preventing the system reset from being asserted.
<b>Affected Conditions / Impacts</b>
The device will hang waiting for the EMU/CMU handshake to complete, requiring a pin reset to recover.
<b>Workaround</b>
When the HFXO is enabled, do not toggle DISONDEMAND from 0 to 1.
<b>Resolution</b>
There is currently no resolution for this issue.

## 2.4 LFXO\_E301 — LFXO Minimum Load Capacitance

<b>Description of Errata</b>
LFXO minimum load capacitance ( $C_L$ ) is higher than the datasheet specification.
<b>Affected Conditions / Impacts</b>
LFXOs with a load capacitance specification of less than 6 pF may not start or may have long startup times, notably when operating at higher temperatures.
<b>Workaround</b>
Select LFXOs with a load capacitance specification of at least 6 pF ( $C_L \geq 6$ pF) and operate the LFXO at a maximum temperature of 125 °C.
<b>Resolution</b>
There is currently no resolution for this issue. The higher load capacitance for revision C devices will be published starting with the 1.0 version of the data sheet.

## 2.5 RADIO\_E308 – Low Output Power for 20 dBm Power Amplifier at High Temperature

<b>Description of Errata</b>
When operating at higher temperatures (85 °C to 125 °C), the output power of the 20 dBm PA is lower than expected.
<b>Affected Conditions / Impacts</b>
Systems operating from 85 °C to 125 °C will experience a lower output power of the 20 dBm PA on the order of 0.5 dB lower than the data sheet specification.
<b>Workaround</b>
There is currently no workaround for this issue.
<b>Resolution</b>
There is currently no resolution for this issue. The lower output power for revision C devices will be published starting with the 1.0 version of the data sheet.

## 2.6 TIMER\_E301 — Continuous Overflow and Underflow Interrupts in Quadrature Counting Mode

<b>Description of Errata</b>
When the TIMER is configured to operate in quadrature decoder mode with the overflow interrupt enabled and the counter value (TIMER_CNT) reaches the top value (TIMER_TOP), the overflow interrupt is requested continuously even if the interrupt flag (TIMER_IF_OF) is cleared. Similarly, if the underflow interrupt is enabled and the counter value reaches zero, the underflow interrupt is requested continuously even if the interrupt flag (TIMER_IF_UF) is cleared. Only after the counter value has incremented or decremented so that the overflow or underflow condition no longer applies can the interrupt be cleared.
<b>Affected Conditions / Impacts</b>
Because the counter is clocked by its CC0 and CC1 inputs in quadrature decoder mode and not the prescaled HPERCLK, overflow and underflow events remain latched as long as TIMER_CNT remains at the value that triggered the overflow or underflow condition. Until the counter is no longer in the overflow or underflow condition, it is not possible to clear the associated interrupt flag.
<b>Workaround</b>
<p>Short of disabling the relevant interrupts, the simplest workaround is to manually increment or decrement TIMER_CNT so that the overflow or underflow condition no longer exists. Insert the following or similar code in the interrupt handler for the timer in question (TIMER0 in this case) to do this:</p> <pre>uint32 intFlags = TIMER_IntGet(TIMER0);  if (intFlags &amp; TIMER_IEN_OF)     TIMER0-&gt;CNT += 1;  if (intFlags &amp; TIMER_IEN_UF)     TIMER0-&gt;CNT -= 1;</pre> <p>It may be necessary for firmware to account for this adjustment in calculations that include the counter value.</p>
<b>Resolution</b>
There is currently no resolution for this issue.

## 2.7 USART\_E301 — Possible Data Transmission on Wrong Edge in Synchronous Mode

Description of Errata
<p>The first bit of the new data word is incorrectly transmitted on the leading clock edge of the subsequent data bit and not the trailing clock edge of the current data bit if the USART is configured to operate in synchronous mode with</p> <ol style="list-style-type: none"> <li>1. USART_CLKDIV_DIV = 0 (clock = <math>f_{HFPERCLK} \div 2</math>),</li> <li>2. USART_CTRL_CLKPHA = 0,</li> <li>3. USART_TIMING_CSHOLD = 1 and</li> <li>4. Data is loaded into the transmit FIFO (say, by the LDMA) at the exact same time as the USART state machine begins to insert the requested one bit time extension of the chip select hold time (USART_TIMING_CSHOLD = 1).</li> </ol>
Affected Conditions / Impacts
<p>Reception of each data bit by the secondary is tied to a specific clock edge. Therefore, the late transmission by the main of the first bit of a word may cause the secondary to receive the incorrect data, especially if the data setup time for the secondary approaches or exceeds one half the shift clock period.</p>
Workaround
<p>Because there is no way to specifically time a write to the transmit FIFO such that it does not occur when the USART state machine changes state, use one of the following workarounds to avoid the risk for data corruption described above:</p> <ul style="list-style-type: none"> <li>• Set USART_CLK_DIV &gt; 0.</li> <li>• Use USART_TIMING_CSHOLD = 0 or USART_TIMING_CSHOLD &gt; 1.</li> <li>• Use USART_CTRL_CLKPHA = 1. This option is particularly useful with SPI flash memories as many support operation in both the CLKPOL = CLKPHA = 0 and CLKPOL = CLKPHA = 1 modes.</li> </ul>
Resolution
<p>There is currently no resolution for this issue.</p>

## 2.8 USART\_E302 — Additional SCLK Pulses Can Be Generated in USART Synchronous Mode

Description of Errata
<p>When inter-character spacing is enabled (USART_TIMING_ICS &gt; 0) and USART_CTRL_CLKPHA = 1 in synchronous main mode, an extra clock pulse is generated after each frame transmitted except the last (that frame which when sent results in both the transmit FIFO and transmit shift register being empty).</p>
Affected Conditions / Impacts
<p>The extra clock pulse generated at the end of the first frame would cause a secondary device to clock in the first bit of the next frame it expects to receive even though the USART is not yet driving that data. The secondary would lose synchronization with the main and erroneously receive all frames after the first.</p>
Workaround
<p>Do not enable inter-character spacing when CLKPHA = 1. If a delay between frames is necessary, insert one manually with a software delay loop. Data cannot be transmitted using DMA in this case.</p>
Resolution
<p>There is currently no resolution for this issue.</p>

## 2.9 USART\_E304 — PRS Transmit Unavailable in Synchronous Secondary Mode

<b>Description of Errata</b>
When the USART is configured for synchronous secondary operation, the transmit output (MISO) is not driven if the signal is routed to a pin using the PRS producer (e.g., SOURCESEL = 0x20 and SIGSEL = 0x4 for USART0).
<b>Affected Conditions / Impacts</b>
Systems cannot operate the USART in synchronous secondary mode if the PRS is used to route the transmit output to the RX (MISO) pin. Operation is not affected in main mode when the transmit output is routed to the TX (MOSI) pin using the PRS producer nor is operation affected in any mode when the GPIO_USARTn_RXROUTE and GPIO_USARTn_TXROUTE registers are used.
<b>Workaround</b>
There is currently no workaround for this issue.
<b>Resolution</b>
There is currently no resolution for this issue.

## 2.10 WDOG\_E301 – Clear Command is Lost Upon EM2 Entry

<b>Description of Errata</b>
If the device enters EM2, while the clear command is still being synchronized, the watchdog counter may not be cleared as expected.
<b>Affected Conditions / Impacts</b>
If the watchdog counter is not cleared as expected, the device can encounter a watchdog reset.
<b>Workaround</b>
Wait for WDOG_SYNCBUSY_CMD to clear before entering EM2.  Note that WDOG can be clocked from one of the low-frequency clock sources and will require additional time to enter EM2 when implementing this workaround.
<b>Resolution</b>
There is currently no resolution for this issue.

### 3. Revision History

#### Revision 0.2

June, 2023

- Updated for device revision C.
- Added [CUR\\_E304](#).
- Updated errata description and workaround for [HFXO\\_E301](#).
- Added [LFXO\\_E301](#).
- Added [RADIO\\_E308](#).

#### Revision 0.1

November, 2021

- Initial release.



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